

CLAIMS

1. (Currently Amended) A system for testing semiconductor devices, comprising:
 - a force retainer mounted on a material handler; and
 - a force locator interposed between the force retainer and a circuit board and, together with the force retainer, adapted to prevent the circuit board from bending; and
 - a stiffener ring mounted on the circuit board and surrounding the force locator.
2. (Previously presented) The system of claim 1 where the force retainer comprises:
 - outer and inner rings; and
 - a plurality of ribs connecting the outer ring to the inner ring.
3. (Currently Amended) The system of claim 1 comprising where the system comprises
 - a test head including a plurality of connectors connecting the test head to the circuit board;
 - where the force retainer includes comprises a plurality of openings between adjacent radial ribs; and
 - where the plurality of connectors protrude through the plurality of openings.
4. (Original) The system of claim 1 where the force retainer is steel.
5. (Original) The system of claim 1 where the force retainer is cast iron.
6. (Original) The system of claim 1 where the force locator is mounted on the circuit board.
7. (Original) The system of claim 1 where the force locator has a same shape as a probe head.
8. (Original) The system of claim 1 where the force locator is adjustable to accommodate spacing limitations between the circuit board and the force retainer.

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9. (Cancelled)

10. (Cancelled)

11. (Currently Amended) The tester of claim 10 13 where the interface unit comprises a probe head attached to the circuit board on one side and having contact pins protruding from another side.

12. (Currently Amended) The tester of claim 11 13 where the force locator is a same shape as the probe head.

13. (Currently Amended) A The tester of claim 10 comprising:
a top plate on a material handler;
a force retainer fixedly mounted on the top plate, the force retainer including an outer
ring connected to an inner ring by a plurality of ribs; and
an interface unit removably mounted on the force retainer and including a force
locator, the force locator being fixedly mounted on a circuit board, where the interface unit
comprises including a circuit board stiffener ring mounted on the circuit board and
surrounding the force locator.

14. (Currently Amended) The tester of claim 9 13 comprising
a test head adapted to provide electrical signals to a the device under test through at least one connector, the at least one connector protruding from at least one open portion between adjacent ribs.

15. (Currently Amended) A method of testing semiconductor devices, comprising:
fixedly mounting a force retainer to a material handler;
removably mounting an interface unit to the force retainer;
mounting a force locator on the interface unit; and
surrounding the force locator with a stiffener ring.

16. (Currently Amended) The method of claim 15 comprising mounting a the
stiffener ring to a circuit board.

17. (Currently amended) The method of claim 15 comprising providing the force retainer with inner and outer rings; and connected with a plurality of ribs connecting the outer ring to the inner ring using at least one radial rib.

18. (Previously presented) The method of claim 15 comprising: positioning a test head on one side of the handler; providing the test head with at least one connector; and threading the connector through the force retainer.

19. (Currently Amended) The method of claim 10 15 comprising: bringing a device under test into contact with the interface unit thereby creating a probe force; directing the probe force from the interface unit to the force retainer; and retaining the probe force using the force retainer.

20. (Currently Amended) The method of claim 10 16 comprising distributing a probe force on the force retainer using the force locator.

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